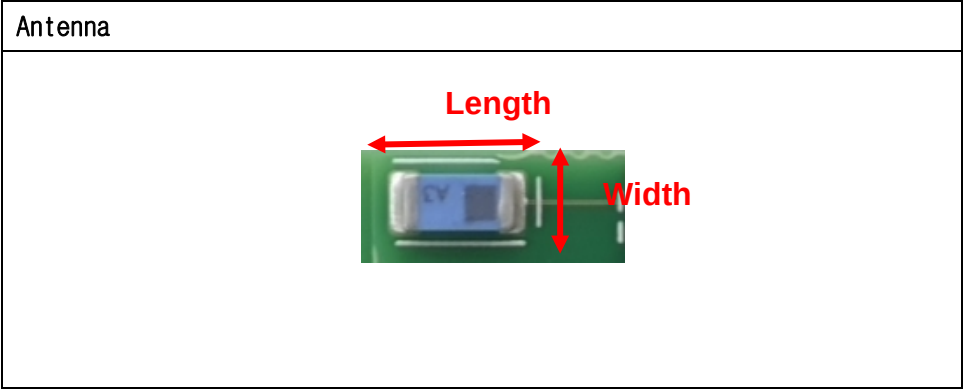


Antenna Information

Item	Contents
Antenna Type	Multilayer Chip Antenna
Antenna peak gain	2.36 dB i
Manufacturer / Model name	AMOTECH Co., Ltd. / -
Address of Manufacturer	5BL-1LOT, 380 Namdongseo-ro, Namdong-Gu, Incheon, KOREA (21629)
Antenna_Length	0.32 cm
Antenna_Width	0.16 cm



Document	Datasheet
Type	Multilayer Chip Antenna
Application	2.4GHz
Part No.	ALA321C3
Revision	9.0

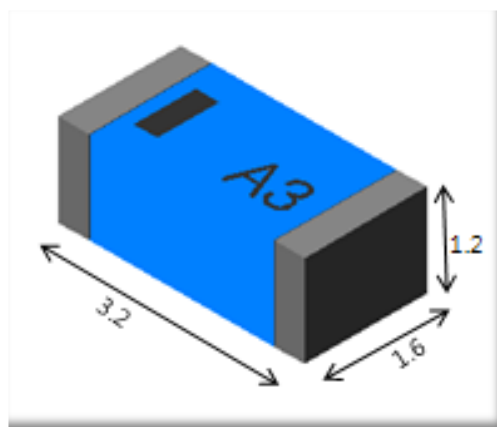
DATASHEET

Application

Bluetooth
Zigbee
WLAN (IEEE 802.11 b/g)
ISM 2.4GHz Wireless Devices

Features

Helical Structure
Small Size ($3.2 \times 1.6 \times 1.2 \text{mm}^3$)
Easy Optimizing
with external lumped matching components
SMT Available under Pb-free Condition
RoHS Compliant



AMOTECH

Notes

The contents of this datasheet are subject to change without notice. Please confirm the specifications and delivery conditions when placing your order.

Revision History

Rev. No	Date	Title	Contents	Page
7	'09.04.07	Format	Changed document format	
8	'14.06.18		Added "Storage Temperature"	3
9	'16.10.31		Revised "Radiation pattern"	
			Added "Cautions"	

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1.2 Mechanical Specifications	3
1.3 Appearance and Material	3
2. PCB Design for Test	4
2.1 Evaluation Board Dimension	4
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1. Specifications

1.1 Electrical Specifications

No	Item	Spec.	Remark
1	Frequency Range [MHz]	2400 ~2485	
2	VSWR	Max 3.0:1	
3	Peak Gain [dBi]	typ. 2.3	
4	Total Avg. Gain [dBi]	typ. -1.6	
5	Efficiency [%]	typ. 70	
6	Polarization	Linear	
7	Impedance [Ω]	Nominal 50	

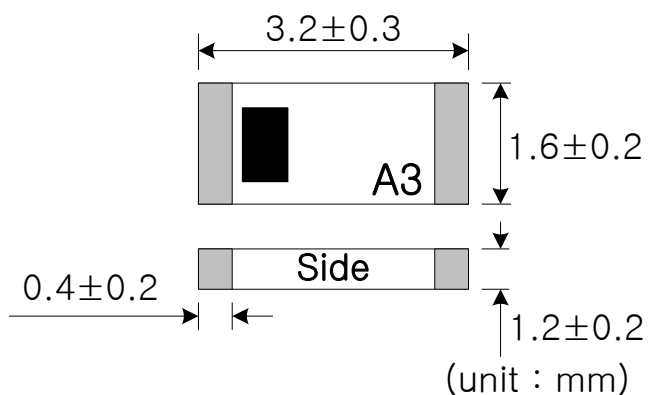
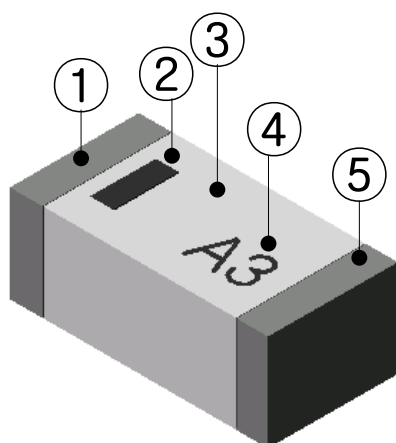
- ✓ The results are measured on the 10x43mm² evaluation board(EVB).
- ✓ See Page 6. for more detail gain parameter

1.2 Mechanical Specifications

No	Item	Spec.	Remark
1	Dimensions (LxWxH)	3.2x1.6x1.2 mm ³	
2	Unit Weight	typ. 20 mg	
3	Operating Temperature	-35 ~ +85 °C	
4	Storage Temperature	-40 ~ +100 °C	

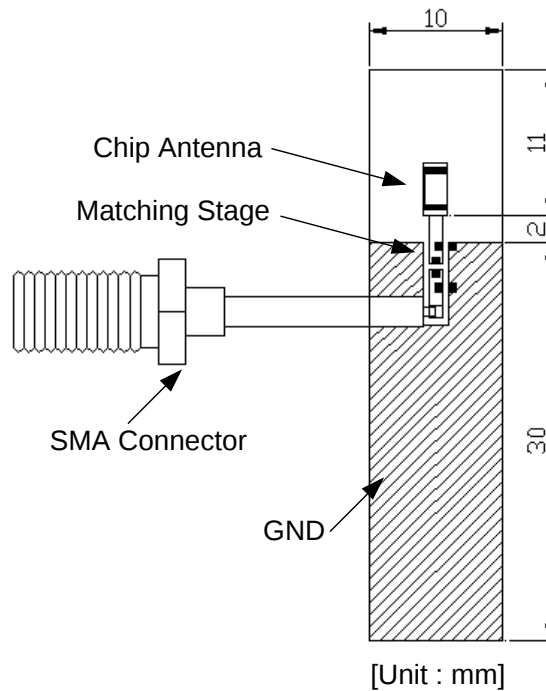
1.3 Appearance & Material

No	Item	Function	Material
①	External Electrode	Soldering, Input Port	Ag/Ni/Sn
②	Direction index	Indication of	Ceramic
③	Ceramic Body	-	Ceramic
④	Model No. index	-	Ceramic
⑤	External Electrode	Soldering	Ag/Ni/Sn



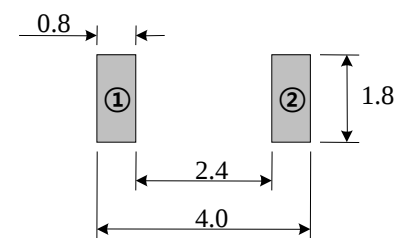
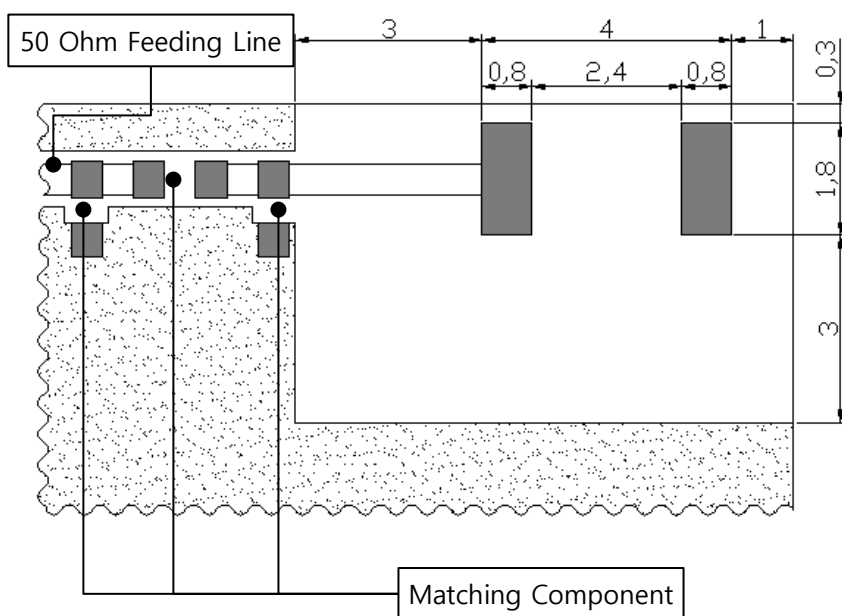
2. PCB Design for Test

2.1 Evaluation Board Dimension



- ✓ Evaluation board size ~ 10x43
- ✓ Fill Cut Area (GND Clearance) ~ 10x13

2.2 PCB Design Guide



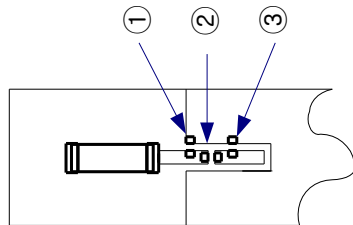
[PCB Solder Land]

No	Pin Assignment
①	Feeding
②	N.C

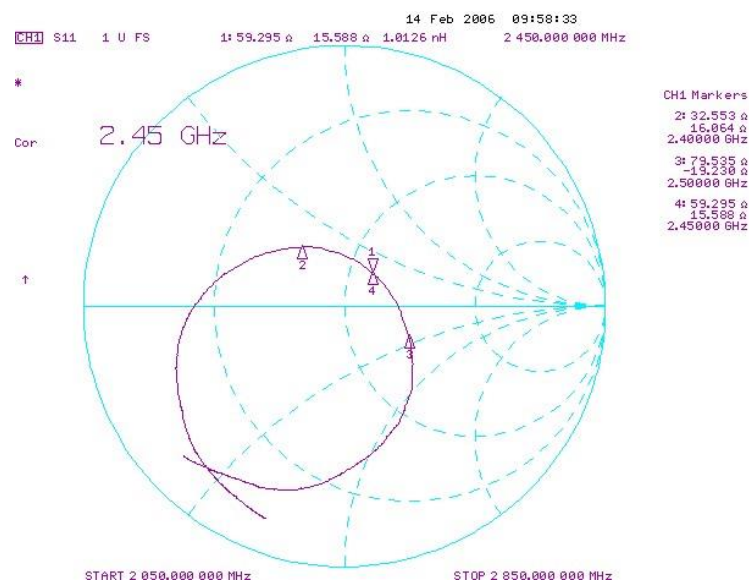
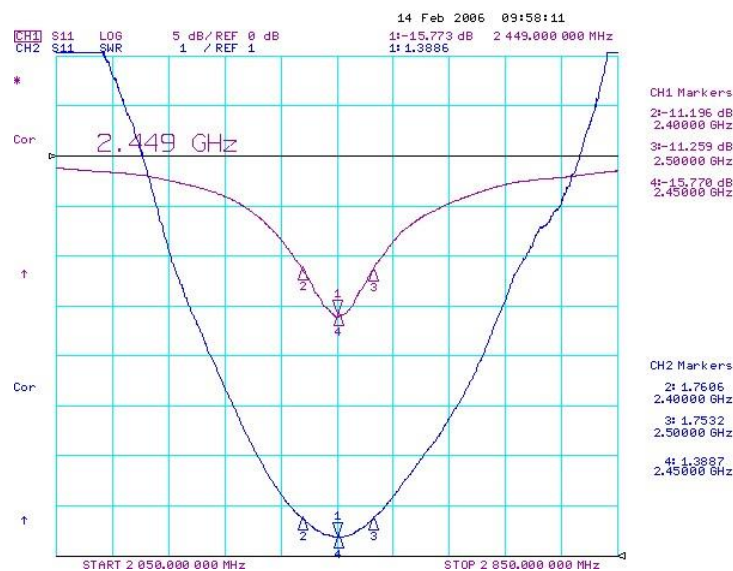
[unit : mm]

3. Measurement Result

3.1 Typical Measurement Result (VSWR/RL, Smithchart)



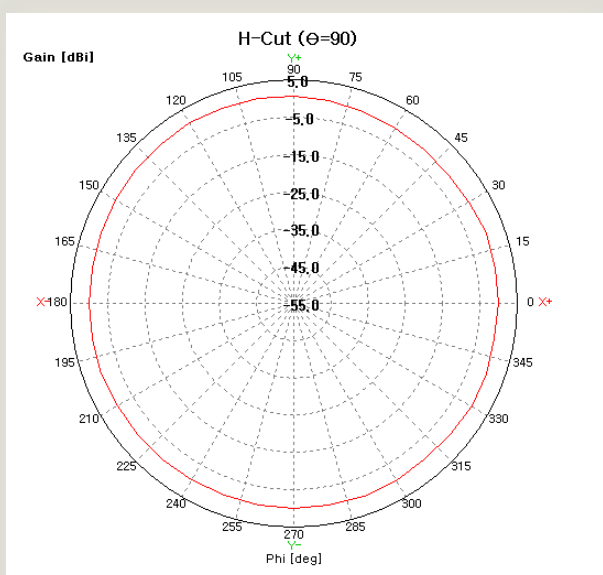
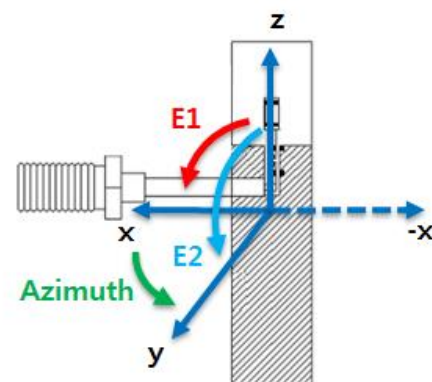
No	Matching Value
①	N.C
②	4.7 nH
③	1.8 nH



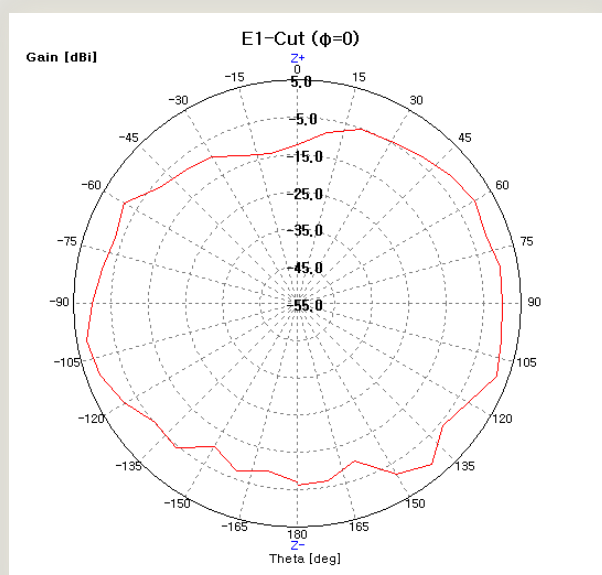
✓ The results are measured on the 10x43mm² evaluation board(EVB).

3.2 Typical Measurement Result (Gain, Radiation Pattern)

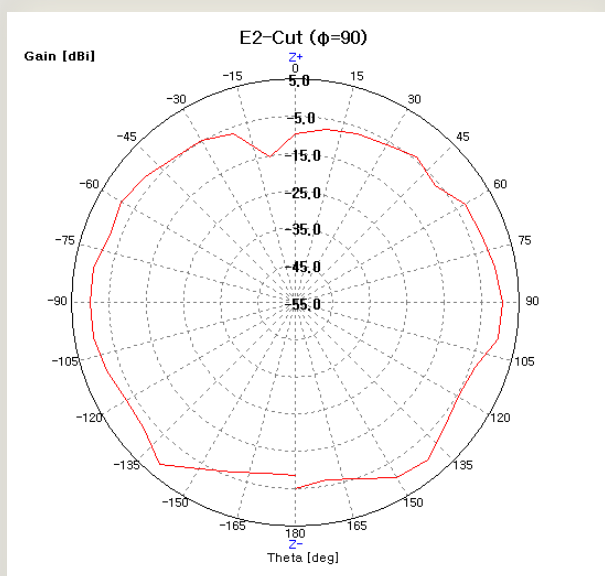
Freq. [MHz]	Peak Gain [dBi]	Avg. Gain [dBi]	Efficiency [%]
2400	2.33	-1.54	70.19
2450	2.36	-1.59	69.40
2500	1.61	-2.60	55.01



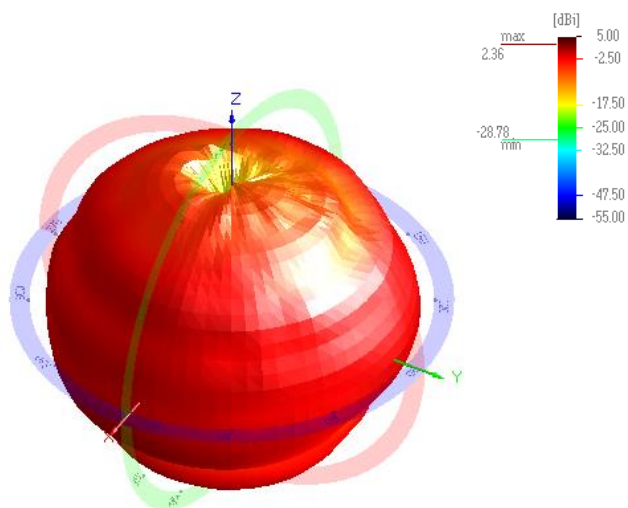
[Azimuth plane @2.45GHz]



[Elevation1 plane @2.45GHz]

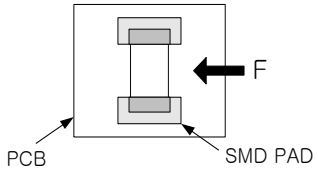


[Elevation2 plane @2.45GHz]



[3D Radiation Pattern @2450MHz]

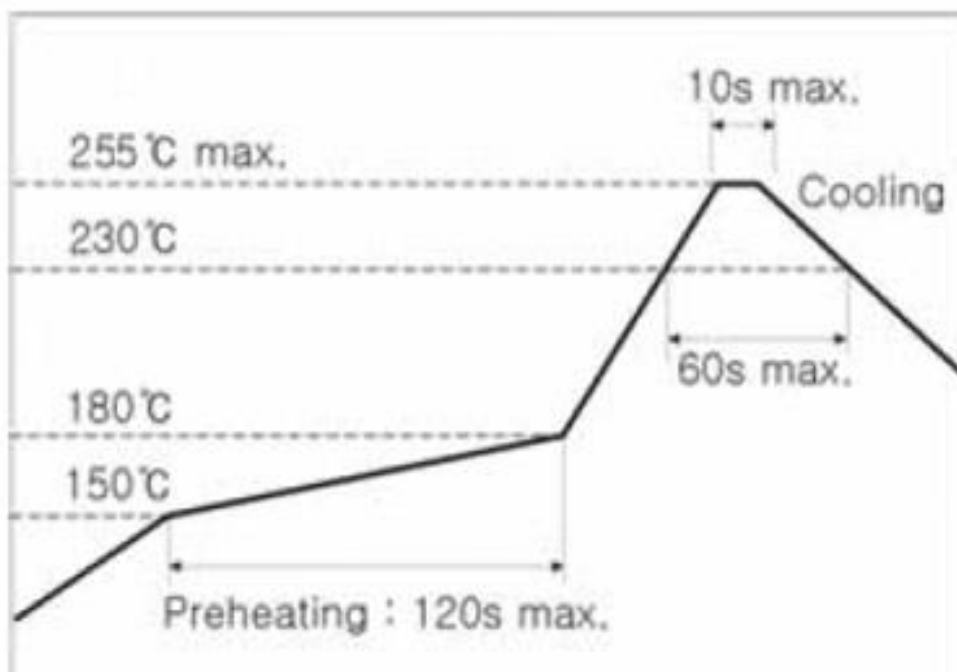
4. Reliability

No	Item	Test Condition	Test Requirements
1	Adhesive Strength of Termination	1. Applied force on SMT chip till detached point from PCB. 	1. No mechanical damage by applied force 2. Strength (F) > 3 kgf
2	Thermal Shock (Cycle)	1. Step 1 : $-40 \pm 3^{\circ}\text{C}$, 30 min Step 2 : $+125 \pm 3^{\circ}\text{C}$, 30 min 2. Number of cycle : 30	1. No visual damage 2. Within electric spec (VSWR)
3	High Temperature Resistance	1. Temperature : $+125 \pm 5^{\circ}\text{C}$ 2. Time : 1000 ± 24 hrs	1. No visual damage 2. Within electric spec (VSWR)
4	Low Temperature Resistance	1. Temperature : $-40 \pm 5^{\circ}\text{C}$ 2. Time : 1000 ± 24 hrs	1. No visual damage 2. Within electric spec (VSWR)
5	Humidity	1. Humidity : 85 % RH Temperature : $+85 \pm 3^{\circ}\text{C}$ 2. Time : 1000 ± 24 hrs	1. No visual damage 2. Within electric spec (VSWR)

5. Cautions (Recommendations)

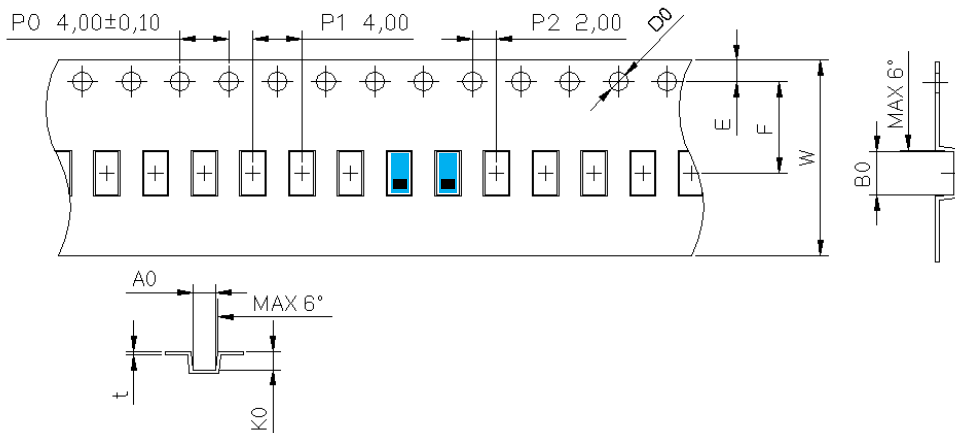
- ✓ Storage environment of parts must be at ambient temperatures of 5 to 40°C and maximum 60%RH humidity
- ✓ The parts should be used within 6 months from the time of delivery. If stored for over 6 months, check for solder-ability before use.

6. Soldering Reflow Profile



7. Packing

7.1 Carrier Tape Dimension



Item	Spec.	Item	Spec.	Item	Spec.
A0	1.90±0.10	P0	4.00 ±0.10	E	1.75±0.10
B0	3.50±0.10	P1	4.00 ±0.10	F	7.50±0.10
K0	1.50±0.10	P2	2.00 ±0.10	W	16.00±0.30
D0	1.55±0.05	-	-	t	0.30±0.05

7.2 Packing Quantity

Item	Quantity	Dimension
Reel	2,000ea	Φ7" * 12mm
Inner Box	6,000ea (3 reel)	185 * 185 * 68 (mm ³)
Outer Box1	30,000ea (5 Inner Box)	375 * 200 * 205 (mm ³)
Outer Box2	60,000ea (10 Inner Box)	390 * 375 * 205 (mm ³)

7.3 Packing Label

AMOTECH Co., Ltd.

5BL-1Lot, 617, Namchon-Dong, Namdong-Gu, Incheon, Korea

Multilayer Chip Antenna

P/N : ALA321C3

Lot No :

Quantity : 2,000 pcs Date : 2010/01/19